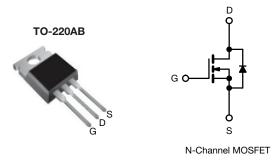
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.243		
Q _g max. (nC)	66			
Q _{gs} (nC)	8			
Q _{gd} (nC)	14			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION Package TO-220AB SiHD15N50E RE3.8

Fackage	TU-22UAD		
Lead (Pb)-free and halogen-free	SiHP15N50E-BE3 ^a		
Lead (PD)-free and halogen-free	SiHP15N50E-GE3		

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	500	V		
Gate-Source Voltage			V _{GS}	± 30	v		
Continuous Drain Current (T _J = 150 °C)	V =======V	T _C = 25 °C T _C = 100 °C	- I _D	14.5			
	V _{GS} at 10 V	T _C = 100 °C		9.2	A		
Pulsed Drain Current ^a			I _{DM}	28			
Linear Derating Factor				1.25	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	136	mJ		
Maximum Power Dissipation			PD	156	W		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		d\//dt	70	V/ns		
Reverse Diode dV/dt ^d			dV/dt	27	v/ns		
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 3.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dl/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.8	0/10	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	500	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		0.62	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Onto any laskana	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage		Ň	/ _{GS} = ± 30 V	-	-	± 1	μA
Zara acto voltogo duoin ovument	1	V _{DS} =	500 V, V _{GS} = 0 V	-	-	10	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	25	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 7.5 A	-	0.243	0.280	Ω
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 7.5 A		-	3.9	-	S
Dynamic		-		•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1162	-	pF
Output capacitance	C _{oss}			-	51	-	
Reverse transfer capacitance	C _{rss}			-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V		-	55	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	164	-	
Total gate charge	Qg			-	33	66	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$V_{GS} = 10 \text{ V}$ $I_D = 7.5 \text{ A}, V_{DS} = 400 \text{ V}$		8	-	nC
Gate-drain charge	Q _{gd}				14	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 400 V, I _D = 12 A,		-	15	30	- ns
Rise time	t _r			-	24	48	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		34	68	
Fall time	t _f	1		-	18	36	
Gate input resistance	Rg	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s			•	•	•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed diode forward current	I _{SM}			-	-	28	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 7.5 \text{ A},$ dl/dt = 100 A/ μ s ^{, V} _R = 25 V		-	265	-	ns
Reverse recovery charge	Q _{rr}			-	3.2	-	μC
Reverse recovery current	I _{RRM}			-	23	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

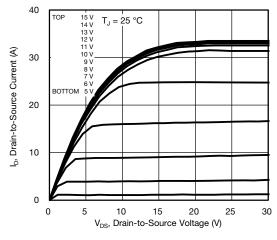


Fig. 1 - Typical Output Characteristics

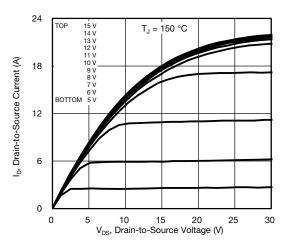


Fig. 2 - Typical Output Characteristics

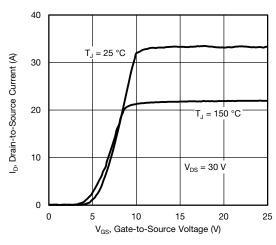


Fig. 3 - Typical Transfer Characteristics

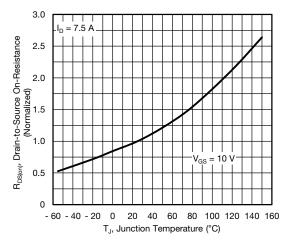


Fig. 4 - Normalized On-Resistance vs. Temperature

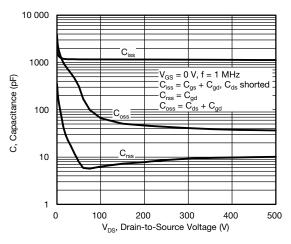


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

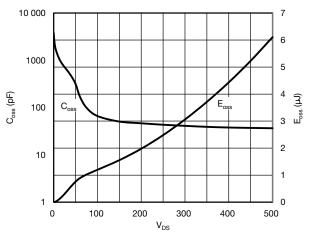


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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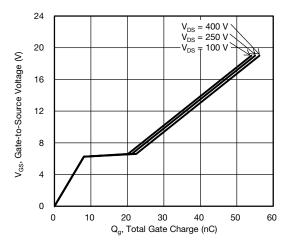


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

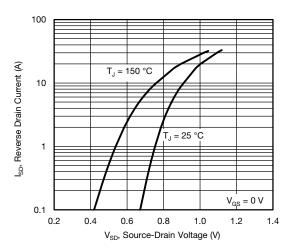
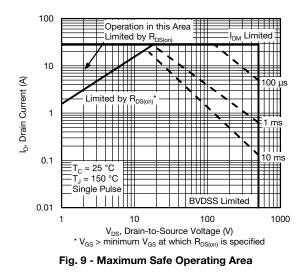


Fig. 8 - Typical Source-Drain Diode Forward Voltage



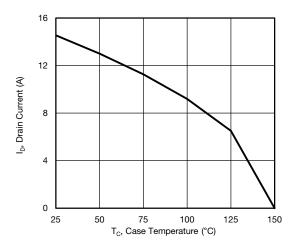


Fig. 10 - Maximum Drain Current vs. Case Temperature

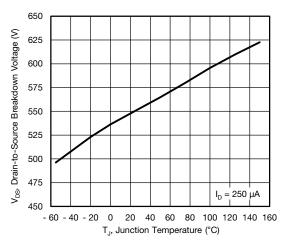
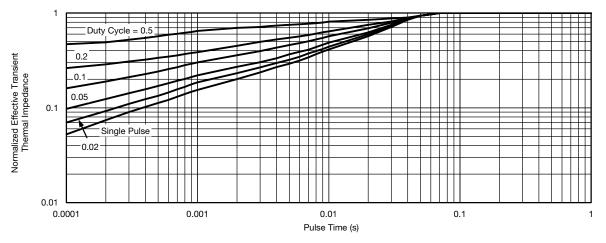


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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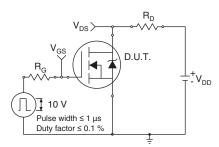


Fig. 13 - Switching Time Test Circuit

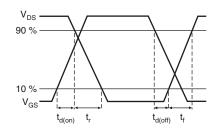


Fig. 14 - Switching Time Waveforms

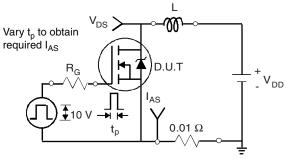


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

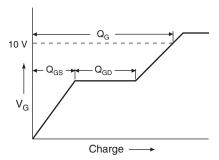


Fig. 17 - Basic Gate Charge Waveform

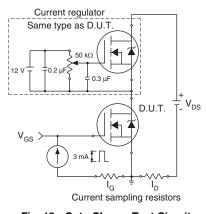


Fig. 18 - Gate Charge Test Circuit

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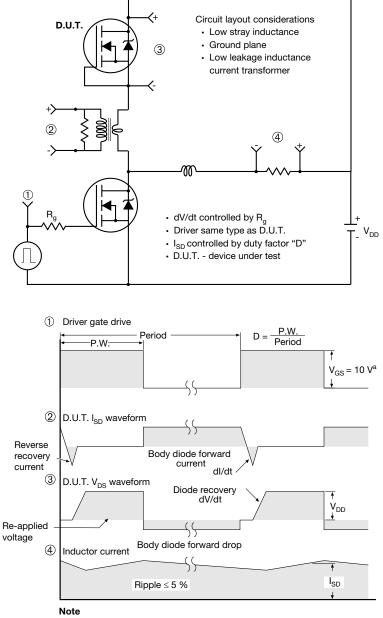
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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